imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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SPECIFICATION

- · Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- · Samsung P/N:
- CL31B106KAHNFNE

(Reference sheet)

- · Description :
- CAP, 10uF, 25V, ±10%, X7R, 1206

A. Samsung Part Number

		<u>C</u> (1		<u>B</u> 3	<u>106</u> ④	<u>K</u> 5	<mark>4</mark> 6	<u>н</u> 7	<u>N</u> 8	<u>F</u> 9	<u>N</u> 10	<u>Е</u> Ш		
1	Series	Samsung Multi-layer Ceramic Capacitor												
2	Size	1206 (inc	h code)		L:	3.20	±0.20n	nm			W:	1.60 ±0.20mm		
3	Dielectric	X7R				8	Inner	elect	rode			Ni		
4	Capacitance	10 uF					Term	inatic	n			Cu		
5	Capacitance	±10 %					Platir	ıg				Sn 100%	(Pb Free)	
	tolerance					9	Produ	uct				Product for Po	OWER application	
6	Rated Voltage	25 V				10	Spec	ial				Reserved for	future use	
1	Thickness	1.60 ±0.20mm				1	Packa	aging				Embossed Ty	/pe, 7" reel	

B. Structure & Dimension



Samsung P/N	Dimension(mm)							
Samsung F/N	L	W	Т	BW				
CL31B106KAHNFNE	3.20 ±0.20	1.60 ±0.20	1.60 ±0.20	0.50 ± 0.30				

C. Samsung Reliablility Test and Judgement Condition

	Judgement	Test condition				
Capacitance	Within specified tolerance	1 ^{kHz} ±10% / 1.0±0.2Vrms				
Tan δ (DF)	0.1 max.	*A capacitor prior to measuring the capacitance is heat treated at 150° +0/-10 $^{\circ}$ for 1 hour and maintained in ambient air for 24±2 hours.				
Insulation	10,000Mohm or 100Mohm× <i>μ</i> F	Rated Voltage 60~120 sec.				
Resistance	Whichever is smaller					
Appearance	No abnormal exterior appearance	Microscope (×10)				
Withstanding	No dielectric breakdown or	250% of the rated voltage				
Voltage	mechanical breakdown					
Temperature	X7R					
Characteristics	(From-55 ℃ to 125 ℃, Capacitance change	should be within ±15%)				
Adhesive Strength	No peeling shall be occur on the	500g⋅f, for 10±1 sec.				
of Termination	terminal electrode					
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)				
		with 1.0mm/sec.				
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder				
-	is to be soldered newly	245±5℃, 3±0.3sec.				
		(preheating : 80~120℃ for 10~30sec.)				
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5°C, 10±1sec.				
Soldering Heat	Tan δ, IR : initial spec.					
Vibration Test	Capacitance change : within $\pm 5\%$ Tan δ , IR : initial spec.	Amplitude : 1.5mm From 10Hz to 55Hz (return : 1min.) 2hours × 3 direction (x, y, z)				
Moisture	Capacitance change : within ±12.5%	With rated voltage				
Resistance	Tan δ : 0.125 max	40±2℃, 90~95%RH, 500+12/-0hrs				
	IR : 500Mohm or 12.5Mohm × <i>μ</i> F					
	Whichever is smaller					
High Temperature	Capacitance change : within ±12.5%	With 150% of the rated voltage				
Resistance	Tan δ : 0.125 max	Max. operating temperature				
	IR : 1,000Mohm or 25Mohm × <i>µ</i> F	1000+48/-0hrs				
	Whichever is smaller					
Temperature	Capacitance change : within ±7.5%	1 cycle condition				
Cycling	Tan δ, IR : initial spec.	Min. operating temperature \rightarrow 25°C				
_		\rightarrow Max. operating temperature \rightarrow 25°C				
		5 cycle test				

X The reliability test condition can be replaced by the corresponding accelerated test condition.

D. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5°C, 10sec. Max)

Product specifications included in the specifications are effective as of March 1, 2013. Please be advised that they are standard product specifications for reference only. We may change, modify or discontinue the product specifications without notice at any time. So, you need to approve the product specifications before placing an order. Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.

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The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

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If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- Aerospace/Aviation equipment
- 2 Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- ④ Military equipment
- *⑤* Disaster prevention/crime prevention equipment
- *ⓐ* Any other applications with the same as or similar complexity or reliability to the applications set forth above.